

**What is claimed is:**

1. A heat-resistant film comprising a film substrate and a heat-resistant slip layer disposed on one surface of the film substrate, the heat-resistant slip layer comprising a binder and a slip additive, wherein the slip additive is a higher fatty acid metal salt composition comprising a free higher fatty acid in an amount of 3 to 30wt% and a metal salt of a higher fatty acid.

2. The heat-resistant film according to claim 1, wherein the free higher fatty acid is stearic acid and the metal salt of higher fatty acid is aluminum stearate.

3. The heat-resistant film according to claim 1, wherein the binder is polymethylmethacrylate.

4. The heat-resistant film according to claim 1, wherein the heat-resistant slip layer comprises the slip additive in an amount of 3 to 9 parts by weight with respect to 100 parts by weight of the binder.

5. The heat-resistant film according to claim 1, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

6. The heat-resistant film according to claim 2, wherein the binder is polymethylmethacrylate.

7. The heat-resistant film according to claim 2, wherein the

heat-resistant slip layer comprises the slip additive in an amount of 3 to 9 parts by weight with respect to 100 parts by weight of the binder.

5 8. The heat-resistant film according to claim 2, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

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9. The heat-resistant film according to claim 3, wherein the heat-resistant slip layer comprises the slip additive in an amount of 3 to 9 parts by weight with respect to 100 parts by weight of the binder.

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10. The heat-resistant film according to claim 3, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

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11. The heat-resistant film according to claim 4, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

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12. The heat-resistant film according to claim 6, wherein the heat-resistant slip layer comprises the slip additive in an amount of 3 to 9 parts by weight with respect to 100 parts by weight of the binder.

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13. The heat-resistant film according to claim 6, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate  
5 and the heat-resistant slip layer.

14. The heat-resistant film according to claim 7, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-  
10 resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

15. The heat-resistant film according to claim 9, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-  
15 resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

16. The heat-resistant film according to claim 11, wherein a high glass transition temperature resin layer having a higher glass transition temperature than the binder of the heat-  
20 resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.

17. A thermal transfer recording medium including a film substrate and a thermal transfer ink layer disposed on one surface of the film substrate and a heat-resistant slip layer disposed on the other surface of the film substrate, the heat-resistant slip layer comprising a binder and a slip additive,  
25 wherein the slip additive is a higher fatty acid metal salt composition comprising a free higher fatty acid in an amount of 3 to 30wt% and a metal salt of a higher fatty acid.  
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18. The thermal transfer recording medium according to claim 17, wherein the free higher fatty acid is stearic acid and the metal salt of higher fatty acid is aluminum stearate.

5 19. The thermal transfer recording medium according to claim 17, wherein the binder is polymethylmethacrylate.

20. The thermal transfer recording medium according to claim 17, wherein the heat-resistant slip layer comprises the slip  
10 additive in an amount of 3 to 9 parts by weight with respect to 100 parts by weight of the binder.

21. The thermal transfer recording medium according to claim 17, wherein a high glass transition temperature resin layer  
15 having a higher glass transition temperature than the binder of the heat-resistant slip layer is interposed between the film substrate and the heat-resistant slip layer.